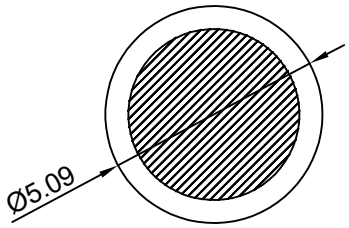
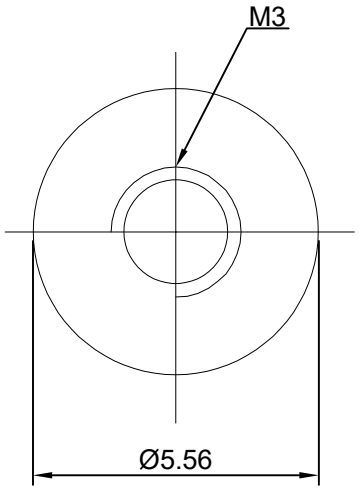
RoHS

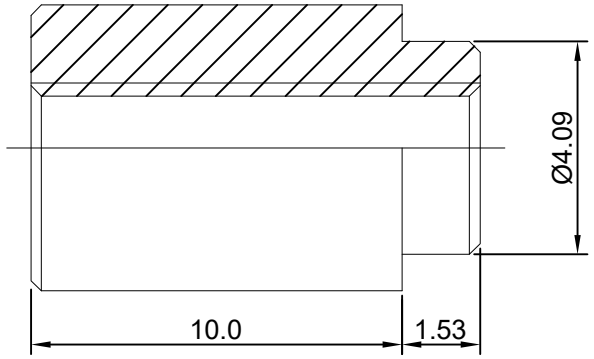
| REV. | ECN NO. | DESCRIPTION | DESIGN | APPROVAL | DATE |
|---|---|---|---|---|---|
| A1 | NEW | 新版发行 | | | 2026.04.11 |




PCB LAYOUT

技术要求：
1.材质：黄铜
2.电镀：镀锡。
3.铆好后不得有松动现象。
4.插脚尖部符合可焊性要求。
5.螺纹需符合通止规/止针要求。
6.螺纹扭矩：0.5Nm.




| | |
|---|---|
| ＞30.±0.4 | X.°± |
| 6-30±0.3 | .X°± |
| 0-6±0.2 | .XX°± |
| ANGLES±1° | .XXX°± |
| UNITS: | mm |

PART NO: TS30556-1153

TITLE: PCB SOLDERING TERMINAL

**XFCN** 兴飞连接器

0769-82001899

www.xfconn.com

DWG NO: /

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| | | | | |
|---|---|---|---|---|
| APPD | Chen ZhiQiang | | | |
| CHKD | Liu Wei | VIEW | | |
| DRAW | Chen HongJiang | SCALE | SHEET | REV |
| DATE | 2026.04.11 | NONE | 1/1 | A1 |